- **Fully Buffered to Offer Maximum isolation from External Disturbance**
- **Package Options include Plastic Small Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs**
- **Typical Maximum Clock Frequency 30 MHz**
- **Typical Power Dissipation per Flip-Flop 6 mW**
- **Dependable Texas Instruments Quality and Reliability**

description

These devices contain two independent J-K negative-edge-triggered flip-flops. A low level at the Preset or Clear inputs sets or resets the outputs regardless of the levels of the other inputs. When Preset and Clear are inactive (high), data at the J and K inputs meeting the setup time requirements are transferred to the outputs on the negative-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not directly related to the fall time of the clock pulse. Following the hold time interval, data at the J and K inputs may be changed without affecting the levels at the outputs. These versatile flip-flops can perform as toggle flip-flops by tying J and K high.

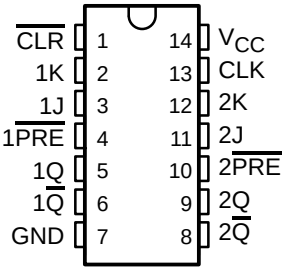
The SN54ALS114A is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ALS114A is characterized for operation from 0°C to 70°C.

FUNCTION TABLE

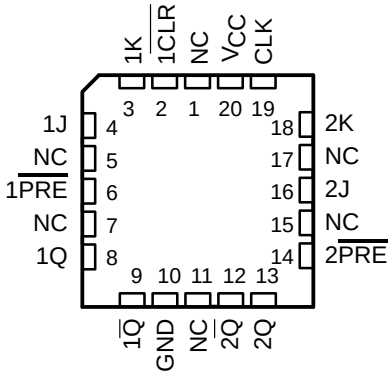
INPUTS					OUTPUTS	
$\overline{PRE}$	$\overline{CLR}$	CLK	J	K	Q	$\overline{Q}$
L	H	X	X	X	H	L
H	L	X	X	X	L	H
L	L	X	X	X	H†	H†
H	H	↓	L	L	Q_0	$\overline{Q}_0$
H	H	↓	H	L	H	L
H	H	↓	L	H	L	H
H	H	↓	H	H	TOGGLE	
H	H	H	X	X	Q_0	$\overline{Q}_0$

† The output levels in this configuration are not guaranteed to meet the minimum levels for V_{OH} if the lows at Preset and Clear are near V_{IL} maximum. Furthermore, this configuration is nonstable; that is, it will not persist when either Preset or Clear returns to its inactive (high) level.

SN54ALS114A . . . J PACKAGE
SN74ALS114A . . . D OR N PACKAGE
(TOP VIEW)

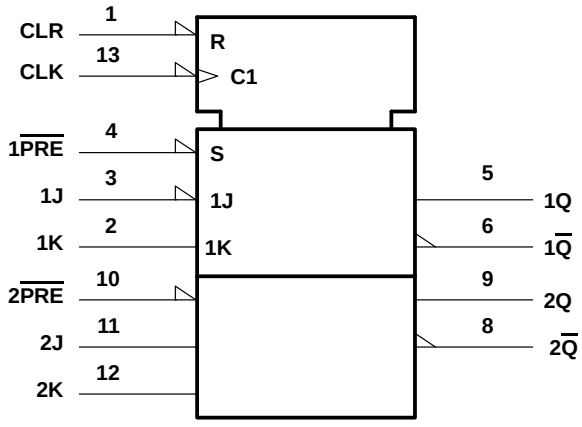


SN54ALS114A . . . FK PACKAGE
(TOP VIEW)



NC–No internal connection

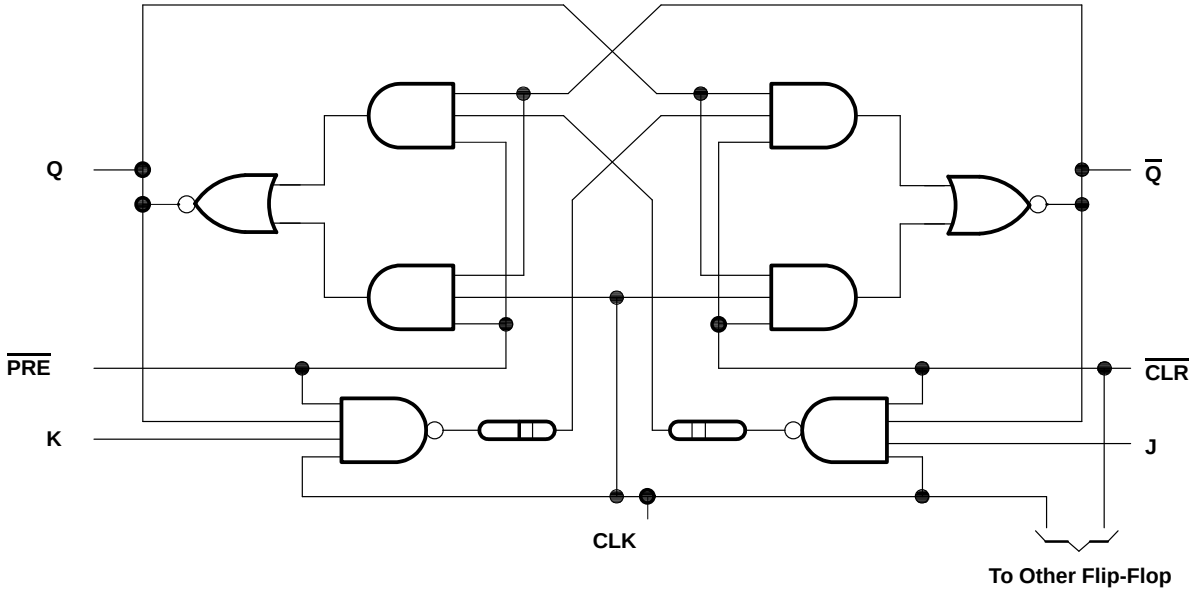
logic symbol‡



‡ This symbol is in accordance with ANSI/IEEE Std 911-1984 and IEC Publication 617-12.

Pin numbers are for D, J, and N packages.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} . . . . . 7 V
Input voltage . . . . . 7 V
Operating free-air temperature range: SN54ALS114A . . . . . −55°C to 125°C
SN74ALS114A . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

recommended operating conditions

			SN54ALS114A			SN74ALS114A			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage		2			2			V
V_{IL}	Low-level input voltage				0.7			0.8	V
I_{OH}	High-level output current				−0.4			−0.4	mA
I_{OL}	Low-level output current				4			8	mA
f_{clock}	Clock frequency		0		25	0		30	mHz
t_w	Pulse duration	$\overline{PRE}$ or $\overline{CLR}$ low	20			10			ns
		CLK high	20			16.5			
		CLK low	20			16.5			
t_{su}	Setup time before CLK↓	Data	25			22			ns
		$\overline{PRE}$ or $\overline{CLR}$ inactive	25			20			
t_h	Hold time, data after CLK↓		0			0			ns
T_A	Operating free-air temperature		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54ALS114A			SN74ALS114A			UNIT
				MIN	TYP†	MAX	MIN	TYP†	MAX	
V_{IK}		V_{CC} = 4.5 V,	I_I = −18 mA			−1.5			−1.5	V
V_{OH}		V_{CC} = 4.5 V to 5.5 V,	I_{OH} = −0.4 mA	V_{CC}−2			V_{CC}−2			V
V_{OL}		V_{CC} = 4.5 V,	I_{OL} = 4 mA		0.25	0.4				V
		V_{CC} = 4.5 V,	I_{OL} = 8 mA					0.35	0.5	
I_I	J, K, or CLK	V_{CC} = 5.5 V,	V_I = 7 V			0.1			0.1	mA
	$\overline{PRE}$ or $\overline{CLR}$					0.2			0.2	
I_{IH}	J, K, or CLK	V_{CC} = 5.5 V,	V_I = 2.7 V			20			20	µA
	$\overline{PRE}$ or $\overline{CLR}$					40			40	
I_{IL}	J, K, or CLK	V_{CC} = 5.5 V,	V_I = 0.4 V			−0.2			−0.2	mA
	$\overline{PRE}$ or $\overline{CLR}$					−0.4			−0.4	
I_O‡		V_{CC} = 5.5 V,	V_O = 2.25 V	−30		−112	−30		−112	mA
I_{CC}		V_{CC} = 5.5 V,	See Note 1		2.5	4.5		2.5	4.5	mA

† All typical values are at V_{CC} = 5 V, T_A = 25°C.
‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.
NOTE 1: I_{CC} is measured with J, K, CLK, and $\overline{PRE}$ grounded, then with J, K, CLK, and $\overline{CLR}$ grounded.

switching characteristics (see Note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R_L = 500 Ω, T_A = MIN to MAX				UNIT
			SN54ALS114A		SN74ALS114A		
			MIN	MAX	MIN	MAX	
f_{max}			25		30		MHz
t_{PLH}	$\overline{PRE}$ or $\overline{CLR}$	Q or $\overline{Q}$	3	29	3	15	ns
t_{PHL}			4	30	4	18	
t_{PLH}	CLK	Q or $\overline{Q}$	3	28	3	15	ns
t_{PHL}			5	31	5	19	

NOTE 2: Load circuit and Voltage waveforms are shown in Section 1.

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